RRP
ELECTRONICS LIMITED

RRP
DEFENSE LTD

FRONTIER

CHAIRMAN MR. RAJENDRA CHODANKAR DELIVERS KEYNOTE AT VLSID 2026

Pune, India

RRP Electronics Ltd. Founder and Chairman, **Mr. Rajendra Chodankar,** headlined the VLSID 2026 inauguration with a compelling Vision Address titled **"Closing the Silicon Loop: India's Journey from Wafer Fabrication to Finished Chips."** Joined by senior government and industry leaders, he outlined RRP's strategic roadmap to establish **indigenous OSAT capabilities** and strengthen India's end to end semiconductor ecosystem.

Mr. Rajendra emphasized the importance of sustainable mobility and AI integration, calling for stronger global local collaboration. His address set the tone for the conference's focus on advancing self reliant technology.

RRP ELECTRONICS LTD POWERS VLSID 2026 AS MAIN SPONSOR

Pune, India

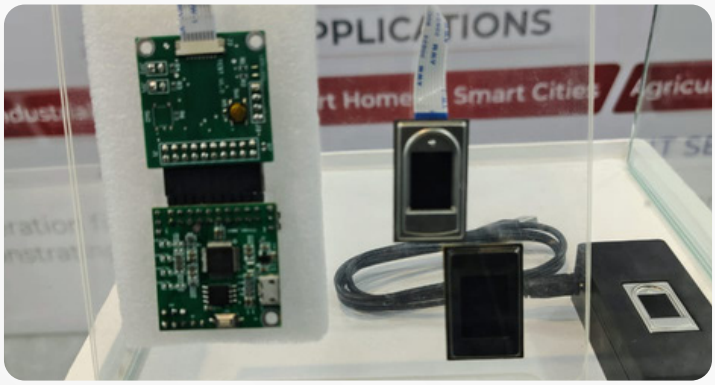
The 39th International Conference, **VLSID 2026,** was held at the JW Marriott in Pune from **January 3–7,** with **RRP Electronics Limited** serving as the event's top supporter. Centered on the theme **"Global Synergy in Silicon: VLSID and Embedded AI for Sustainable Computing and Next Gen Electrified Mobility,"** the conference brought together leading tech innovators, academic visionaries, and policymakers under one collaborative platform.

RRP's support underscored India's commitment to semiconductor self reliance, a vision reinforced by Chairman **Mr. Rajendra Chodankar,** who emphasized the importance of domestic production during the launch. "This partnership closes the silicon loop from wafer to finished chips," he stated.

The funding enabled meaningful ecosystem collaboration and supported key sessions, aligning closely with the objectives of Atmanirbhar Bharat.

RRP ELECTRONICS LTD LAUNCHES 'SAMVED' FINGERPRINT SENSOR MODULES, STRENGTHENING INDIA'S BIOMETRIC SELF-RELIANCE

Pune, India



RRP Electronics has introduced its Samved Fingerprint Sensor modules, marking a major milestone in strengthening India's biometric hardware ecosystem through advanced design and domestic manufacturing. The launch supports India's semiconductor self reliance goals and underscores RRP's evolution from OSAT infrastructure development to product driven innovation.

The SAṂVED modules feature 508 DPI capacitive sensing, patented noise-suppression technology, with compact and large-area variants designed for secure, reliable biometric authentication across multiple applications.

Ms. Apoorva Raut, CTO of RRP Electronics, stated, *"This is a significant advancement in biometric hardware manufacturing in India, contributing to the growth of local design and manufacturing capabilities. These products are manufactured in India, enabling rapid customisation and deployment for our customers."*

Founder and Chairman **Mr. Rajendra Chodankar** highlighted that RRP's OSAT facility was established in record time—beginning chip production in April 2025 and swiftly advancing into product development. He noted that the company's next major milestone is **wafer level packaging,** even as it continues to address challenges in advanced product design and broader semiconductor value chain expansion.

RRP has partnered with Taiwan-based Horngcom for manufacturing and plans to expand into SIM cards and payment cards, further deepening **India's domestic semiconductor capabilities.**

CTO MS. APOORVA RAUT PARTICIPATES IN VLSID 2026 PANEL DISCUSSION

Pune, India

Day 2 of VLSID 2026 continued the momentum of collaboration and innovation shaping India's semiconductor landscape. For RRP Electronics Ltd., a key highlight was the participation of CTO **Ms. Apoorva Raut** in the panel discussion titled "Swadeshi to Silicon: Advancing India's Product Led Semiconductor Future." Appreciative of the opportunity to participate in important discussions that will shape India's semiconductor future, Ms. Apoorva promoted product-led manufacturing expansion.

With distinguished business leaders from DSCI and MosChip, the conversation centered on boosting domestic capabilities and expanding India's semiconductor ecosystem. Engaging conversations with students, business leaders, and academics took place at the RRP Electronics Ltd. booth, sharing possibilities, ideas, and insights that propel innovation.

RRP ELECTRONICS' BOOTH DRAWS CROWDS AT VLSID 2026

Pune, India

At VLSID 2026, RRP Electronics Ltd. stood out in the exhibitor lineup, reinforcing RRP's commitment to India's semiconductor supply chain.

On Day 2, the booth hosted interactions with students, startups, and experts on OSAT/ATMP manufacturing, fuelled by curiosity and purpose.

RRP ELECTRONICS LTD AT WORLD ECONOMIC FORUM 2026:

ADVANCING GLOBAL DIALOGUE IN SEMICONDUCTOR MANUFACTURING

Participation at the Europe–India Cooperation Forum

WEF, Davos, Switzerland

RRP Electronics Ltd. was also pleased to participate in the Europe–India Cooperation Forum, an invitation-only platform bringing together European and Indian leaders to discuss innovation and long-term partnerships.

Mr. Venkatesh Kumar, Finance Controller, represented the company and contributed perspectives on how strategic capital allocation and leadership enable cross-border scale in technology-driven manufacturing enterprises.

Pre-WEF Engagement in Zurich

WEF, Zurich, Switzerland

The journey to Davos began with a pre-WEF gathering in Zurich, where early discussions centered around semiconductor innovation, manufacturing-led growth, and building resilient, future-ready ecosystems.

These engagements set the tone for deeper dialogue and strategic collaboration during the Davos convening period.

On-Ground Engagement at ET House

WEF, Davos, Switzerland

During WEF 2026, the RRP Electronics team operated from ET House, Promenade 120, engaging with global leaders, policymakers, investors, and industry stakeholders.

The interactions focused on:

- Semiconductor manufacturing expansion
- Cross-border technology partnerships
- Supply-chain resilience
- Forward-integrated manufacturing models

The platform provided valuable opportunities to exchange insights and explore collaborative pathways for scaling advanced electronics manufacturing.

LEADERSHIP ENGAGEMENT AND INTERACTIONS

World Economic Forum, Davos, Switzerland

RRP ELECTRONICS SIGNS STRATEGIC MOU WITH KLEOS TO ESTABLISH 5G+/6G MANUFACTURING FACILITY IN INDIA

World Economic Forum, Davos, Switzerland

During the World Economic Forum in Davos, RRP Electronics Ltd announced the signing of a Memorandum of Understanding (MoU) with Kleos, a leading French group specializing in the design of 5G+ and 6G platforms. The MoU was signed by Mr. Rajendra Chodankar, Founder and Chairman of RRP Electronics Ltd, and Mr. George El Aily, CEO of Kleos.

This agreement marks the culmination of over six months of detailed technical evaluation and market analysis aimed at introducing a state-of-the-art, indigenous 5G+/6G production facility in India. It is a significant milestone in strengthening India's telecom manufacturing ecosystem and advancing indigenous technology capabilities.

Strategic Vision:

The collaboration combines:

- RRP's semiconductor manufacturing capabilities
- Kleos' advanced 5G+/6G RAN technology

Together, the partners aim to deliver an end-to-end, sovereign telecom platform manufactured in India.

Industry Impact:

The proposed platform will enable telecom operators in India and across the globe to deploy:

- High-capacity, ultra-low-latency 5G+/6G base stations
- Secure and scalable connectivity infrastructure
- Backbone systems supporting autonomous mobility, UAV taxis, advanced IoT ecosystems, and other next-generation applications

RRP ELECTRONICS LTD AND JPS TECHNOLOGIES UK LTD SIGN MOU TO ESTABLISH OSAT/ATMP FACILITY IN WALES, UK

World Economic Forum, Davos, Switzerland

RRP Electronics Ltd. announced the signing of a Memorandum of Understanding (MoU) with JPS Technologies Ltd. (United Kingdom) to establish an OSAT/ATMP semiconductor facility in Wales, UK.

This facility will replicate RRP Electronics' Mumbai's operation model and focus on legacy semiconductor packaging, with strong emphasis on the automotive sector, a critical and rapidly expanding market requiring high-reliability semiconductor solutions.

Strategic Objectives

The partnership aims to:

- Strengthen UK's semiconductor
- manufacturing capability.
- Enhance automotive and industrial supply-chain resilience.
- Support the growing semiconductor
- ecosystem in UK and Europe.
- Enable knowledge transfer, skill development, and long-term innovation.

JPS Technologies UK Ltd. has expressed strong support for the initiative, and with encouraging signals from the UK Government, the partners remain optimistic about commencing operations in 2026.

This MoU marks a key step in RRP Electronics' global expansion strategy and reinforces its commitment to building a globally connected, future-ready semiconductor ecosystem through strategic international collaborations.

RRP AT WIN LOUNGE, DAVOS 2026

WIN Lounge, Hotel Schatzalp, Davos

Ms. Apoorva represented RRP at the second edition of the WIN Lounge hosted by the Women Inspiring Network (WIN) during World Economic Forum Week in Davos. The exclusive platform brought together global leaders across business, policy, capital, and innovation to shape women-led conversations on leadership and impact.

She participated in the panel discussion titled **"Future of Capital: Funding Inclusive Innovation and Purpose-Led Ventures,"** which focused on reimagining capital flows to support equitable innovation, sustainable enterprises, and purpose-driven growth models.

Her participation reflected RRP's commitment to responsible innovation and inclusive ecosystem building, contributing valuable insights to discussions on how capital can enable long-term, impact-oriented progress.

RRP ELECTRONICS LTD SHOWCASES SEMICONDUCTOR EXPANSION PLANS AT DAVOS 2026

Davos, Switzerland

At the CNBC TV18 studios in Davos, Mr. Rajendra Chodankar, Founder and Chairman of RRP Electronics Ltd., highlighted the company's progress under India's Semiconductor Mission, an integral part of the 'Make in India' initiative.

RRP commissioned its OSAT facility in September 2024 with government approvals and subsidy support. Cricket legend **Sachin Tendulkar** has come on board as a strategic investor, further strengthening the company's long term vision. RRP now aims to launch its first prototype thermal imaging chip next quarter, integrate it into a complete camera system, and scale to commercial production by the end of 2027.

REPUBLIC DAY CELEBRATION

RRP Electronics Ltd. Office

A gathering of staff marked RRP Electronics' tribute to India's 77th Republic Day in Navi Mumbai, where the national flag was hoisted in a morning ceremony honoring the Constitution and the values of unity, fairness, and the quiet strength that anchors our democracy.

A moment that stirred pride, bond, and common purpose, driving progress in India forward. Rooted in values like honesty, collective effort, and progress through invention, RRP reconfirmed its role in shaping a resilient India, achieved by sharpening craftsmanship and advancing technology.

RRP S4E INNOVATION LTD CELEBRATES 8 YEARS OF GROWTH AND INNOVATION

RRP S4E Innovation Ltd. Office

On January 22, 2018, a vision was set in motion. Eight years later, S4E Innovation Ltd has evolved into a strong Limited Company, shaped by resilience, innovation, and collective effort. What started as an individual idea has grown steadily—not through haste, but through deliberate progress. Our achievements reflect consistent teamwork, thoughtful use of technology, and a commitment to seeing every plan through with integrity.

This mark stands as proof of Honorable Chairman Rajendra Chodankar's forward-thinking guidance, where foresight shaped direction, and trust in new ideas now fuels lasting progress. Standing alongside are experienced leaders and those who first stepped into the role, each upholding company standards through steady work and quiet dedication.

Eight years of impact comes to a close, yet RRP S4E moves forward strengthened in purpose, bolder in intent. Together, we grow. Together, we succeed.

REPUBLIC DAY CELEBRATION

RRP S4E Innovation Ltd. Office

A flutter of colour marked the morning at RRP S4E Innovation Ltd, where staff gathered around the national flag in quiet respect, paying tribute through shared ritual to the founding ideals of India's journey.

That moment signified the importance of discipline, honesty, and working together that help shape strong nations and companies. RRP S4E stood firm on driving change, striving for top results, while supporting India's tech journey.

RRP S4E (RRP DEFENSE LTD) TEAM SUCCESSFULLY COMPLETES HIGH-ALTITUDE PRODUCT TRIALS IN LADAKH

Leh- Ladakh, Jammu and Kashmir

RRP S4E Innovation Ltd. (RRP Defense Ltd.) marked a significant achievement as its technical team successfully completed product trials in the extreme climatic conditions of Leh–Ladakh, where temperatures dropped to –20°C.

A Critical Milestone in Product Validation

Conducting and successfully clearing trials in harsh, high-altitude environments is a major accomplishment. Sub-zero temperatures and challenging terrain test the true reliability, durability, and operational performance of any system. Successfully validating the product under these conditions demonstrates that it meets stringent operational standards required for defense and field applications. The achievement reinforces confidence in the product's robustness & readiness for demanding real-world deployment

Technical Team on Ground

A dedicated technical team from RRP S4E Innovation (RRP Defense Ltd.) travelled to Leh to execute and closely monitor the environmental and performance trials. Their hands-on presence ensured accurate testing, real-time analysis, and comprehensive validation under authentic field conditions.

Purpose of the Trials

The objective of the visit was to conduct environmental and performance evaluations in real high-altitude, sub-zero conditions. The trials were designed to assess:

- Functional reliability in extreme cold
- Structural and operational robustness
- Overall readiness for deployment in challenging terrains

The successful completion of these trials represents a strong step forward in ensuring that RRP S4E Innovation's solutions are field-ready, dependable, and capable of performing in the most demanding environments.

This achievement reflects the company's commitment to engineering excellence, rigorous validation standards, and mission-critical reliability.

RRP DEFENSE LTD RECEIVES APPRECIATION FROM 25TH BATTALION, THE MADRAS REGIMENT

RRP S4E Innovation Ltd.

> Their high level of professional and technical competence along with their helpful and forthcoming approach in assisting our soldiers with the operation and handling of the equipment reflects the strong organisation commitment of RRP Defense Ltd.
>
> **From the Indian Army**

RRP Defense Ltd. has received a formal letter of appreciation from the Commanding Officer of the 25th Battalion, The Madras Regiment, recognizing the exceptional service and technical support provided by its engineering team. The letter, addressed to Mr. Rajendra Chodankar, Founder and Chairman of RRP Defense Ltd., commends the professionalism and dedication demonstrated by the company's service engineers during their engagement with the unit.

The appreciation specifically acknowledged the contributions of:

- Mr. Ranjit Balan *(Chief Trial Officer)*
- Mr. Dinesh Jangam *(Technical Engineer)*
- Mr. Sani Khaire *(Technical Engineer)*
- Mr. Karan Mane *(Trials Specialist)*

The team was praised for carrying out maintenance activities and providing technical assistance in a thoroughly professional manner, with strong and consistent focus on equipment reliability and operational efficiency.

Commitment to Excellence in Field Support

The letter commended the team for their strong technical competence, proactive attitude, and readiness to assist soldiers in operating and handling the equipment. Their support ensured the seamless functioning of critical systems and demonstrated RRP Defense Ltd.'s commitment to quality, reliability, and service excellence.

The Commanding Officer further expressed appreciation for the ongoing cooperation and shared confidence in continued collaboration.

This recognition from a distinguished Army unit stands as a testament to RRP Defense Ltd.'s dedication to equipping India's defense forces with dependable technology and responsive technical support.

DISTINGUISHED ARMY OFFICER VISITS RRP DEFENSE LTD

RRP S4E Innovation Ltd. Office

RRP S4E Innovation Ltd. (RRP Defense Ltd.) had the honour of hosting a distinguished Lieutenant General from the Indian Army at its premises. The visit provided an opportunity to showcase the company's facilities, research and development capabilities, and ongoing work in specialized domains supporting India's defense ecosystem.

During the visit, the delegates were briefed on RRP S4E's technological initiatives and its efforts toward developing indigenous and future-ready solutions. The interaction reflected the shared commitment to strengthening India's defense capabilities through innovation and self-reliance.

The visit reinforced the organisation's dedication to contributing meaningfully to India's vision of Atmanirbhar Bharat in defense technologies.